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R8C/18 Group, R8C/19 Group SINGLE-CHIP 16-BIT CMOS MCU

REJ03B0124-0140 Rev.1.40 Apr 14, 2006

1. Overview

These MCUs are fabricated using a high-performance silicon gate CMOS process, embedding the R8C/Tiny Series CPU core, and is packaged in a 20-pin molded-plastic LSSOP, SDIP or a 28-pin plastic molded-HWQFN. It implements sophisticated instructions for a high level of instruction efficiency. With 1 Mbyte of address space, they are capable of executing instructions at high speed.

Furthermore, the R8C/19 Group has on-chip data flash ROM (1 KB x 2 blocks).

The difference between the R8C/18 Group and R8C/19 Group is only the presence or absence of data flash ROM. Their peripheral functions are the same.

1.1 Applications

Electric household appliances, office equipment, housing equipment (sensors, security systems), general industrial equipment, audio equipment, etc.



1.2 Performance Overview

Table 1.1 outlines the Functions and Specifications for R8C/18 Group and Table 1.2 outlines the Functions and Specifications for R8C/19 Group.

Table 1.1 Functions and Specifications for R8C/18 Group

Table 1.1 F	ltem	Specification
CPU	Number of fundamental	89 instructions
	instructions	
	Minimum instruction execution	50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V)
	time	100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)
	Operation mode	Single-chip
	Address space	1 Mbyte
	Memory capacity	Refer to Table 1.3 Product Information for R8C/18
		Group
Peripheral	Ports	I/O ports: 13 pins (including LED drive port)
Functions		Input port: 3 pins
	LED drive ports	I/O ports: 4 pins
	Timers	Timer X: 8 bits × 1 channel, timer Z: 8 bits × 1 channel
		(Each timer equipped with 8-bit prescaler)
		Timer C: 16 bits × 1 channel
		(Input capture and output compare circuits)
	Serial interfaces	1 channel
	Cona monacc	Clock synchronous serial I/O, UART
		1 channel
		UART
	Comparator	1-bit comparator: 1 circuit, 4 channels
	Watchdog timer	15 bits × 1 channel (with prescaler)
	Waterlady times	Reset start selectable, count source protection mode
	Interrupts	Internal: 10 sources, External: 4 sources, Software: 4
	Interrupts	sources,
		Priority levels: 7 levels
	Clock generation circuits	2 circuits
	Clock generation on outs	Main clock oscillation circuit (with on-chip feedback
		resistor)
		On-chip oscillator (high speed, low speed)
		High-speed on-chip oscillator has frequency
		adjustment function
	Oscillation stop detection	Main clock oscillation stop detection function
	function	Wall Clock Oscillation stop detection function
	Voltage detection circuit	On-chip
	Power-on reset circuit	On-chip
Electric	Supply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz)
Characteristics	Cappi, remage	VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz)
Gridiadionolio	Current consumption	Typ. 9 mA (VCC = 5.0 V, f(XIN) = 20 MHz, comparator stopped)
		Typ. 5 mA (VCC = $3.0V$, f(XIN) = 10 MHz, comparator stopped)
		Typ. 35 μ A (VCC = 3.0 V, wait mode, peripheral clock off)
		Typ. 0.7 μ A (VCC = 3.0 V, wait mode)
Flash Memory	Programming and erasure voltage	VCC = 2.7 to 5.5 V
I ladii Wollidiy	Programming and erasure	100 times
	endurance	100 111100
Operating Ambi	ent Temperature	-20 to 85°C
	on tomporatoro	-40 to 85°C (D version)
Package		20-pin molded-plastic LSSOP
. aonago		20-pin molded-plastic SDIP
		28-pin molded-plastic HWQFN
		1 - c Forded Praede Fift & 11

Table 1.2 Functions and Specifications for R8C/19 Group

	Item	Specification		
CPU	Number of fundamental	89 instructions		
	instructions			
	Minimum instruction	50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V)		
	execution time	100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)		
	Operation mode	Single-chip		
	Address space	1 Mbyte		
	Memory capacity	Refer to Table 1.4 Product Information for R8C/19		
		Group		
Peripheral	Ports	I/O ports: 13 pins (including LED drive port)		
Functions		Input port: 3 pins		
	LED drive ports	I/O ports: 4 pins		
	Timers	Timer X: 8 bits x 1 channel, timer Z: 8 bits x 1 channel		
		(Each timer equipped with 8-bit prescaler)		
		Timer C: 16 bits x 1 channel		
		(Input capture and output compare circuits)		
	Serial interfaces	1 channel		
		Clock synchronous serial I/O, UART		
		1 channel		
		UART		
	Comparator	1-bit comparator: 1 circuit, 4 channels		
	Watchdog timer	15 bits x 1 channel (with prescaler)		
		Reset start selectable, count source protection mode		
	Interrupts	Internal: 10 sources, External: 4 sources, Software: 4		
		sources,		
		Priority levels: 7 levels		
	Clock generation circuits	2 circuits		
		Main clock generation circuit (with on-chip feedback		
		resistor)		
		On-chip oscillator (high speed, low speed)		
		High-speed on-chip oscillator has frequency		
		adjustment function		
	Oscillation stop detection	Main clock oscillation stop detection function		
	function			
	Voltage detection circuit	On-chip		
	Power-on reset circuit	On-chip		
Electric	Supply voltage	VCC = 3.0 to 5.5 V (f(XIN) = 20 MHz)		
Characteristics		VCC = 2.7 to 5.5 V (f(XIN) = 10 MHz)		
	Current consumption	Typ. 9 mA (VCC = 5.0 V, f(XIN) = 20 MHz, comparator stopped)		
		Typ. 5 mA (VCC = 3.0 V, f(XIN) = 10MHz, comparator stopped)		
		Typ. 35 μ A (VCC = 3.0 V, wait mode, peripheral clock off)		
		Typ. 0.7 μA (VCC = 3.0 V, stop mode)		
Flash Memory	Programming and erasure voltage	VCC = 2.7 to 5.5 V		
	Programming and erasure	10,000 times (data flash)		
	endurance	1,000 times (program ROM)		
Operating Ambi	ent Temperature	-20 to 85°C		
		-40 to 85°C (D version)		
Package		20-pin molded-plastic LSSOP		
		20-pin molded-plastic SDIP		
		28-pin molded-plastic HWQFN		

1.3 Block Diagram

Figure 1.1 shows a Block Diagram.

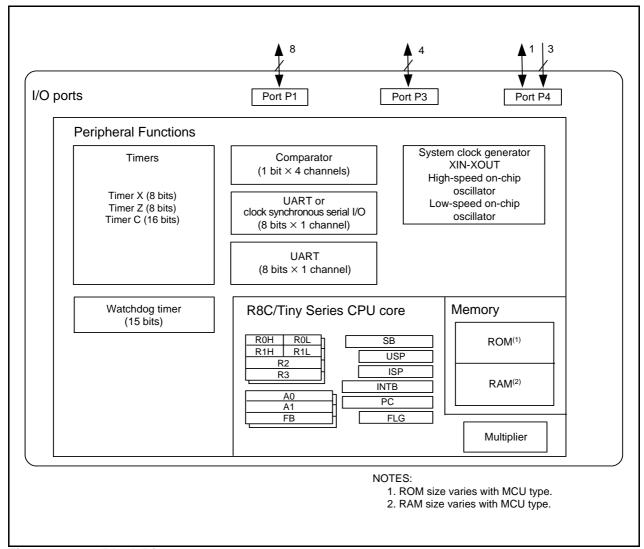


Figure 1.1 Block Diagram

1.4 Product Information

Table 1.3 lists Product Information for R8C/18 Group and Table 1.4 lists Product Information for R8C/19 Group.

Table 1.3 Product Information for R8C/18 Group

Current of Apr. 2006

Type No.	ROM Capacity	RAM Capacity	Package Type	Remarks
R5F21181SP	4 Kbytes	384 bytes	PLSP0020JB-A	Flash memory version
R5F21182SP	8 Kbytes	512 bytes	PLSP0020JB-A	
R5F21183SP	12 Kbytes	768 bytes	PLSP0020JB-A	
R5F21184SP	16 Kbytes	1 Kbyte	PLSP0020JB-A	
R5F21181DSP (D)	4 Kbytes	384 bytes	PLSP0020JB-A	D version
R5F21182DSP (D)	8 Kbytes	512 bytes	PLSP0020JB-A	
R5F21183DSP (D)	12 Kbytes	768 bytes	PLSP0020JB-A	
R5F21184DSP (D)	16 Kbytes	1 Kbyte	PLSP0020JB-A	
R5F21181DD	4 Kbytes	384 bytes	PRDP0020BA-A	Flash memory version
R5F21182DD	8 Kbytes	512 bytes	PRDP0020BA-A	
R5F21183DD	12 Kbytes	768 bytes	PRDP0020BA-A	
R5F21184DD	16 Kbytes	1 Kbyte	PRDP0020BA-A	
R5F21182NP	8 Kbytes	512 bytes	PWQN0028KA-B	Flash memory version
R5F21183NP	12 Kbytes	768 bytes	PWQN0028KA-B	
R5F21184NP	16 Kbytes	1 Kbyte	PWQN0028KA-B	

(D): Under Development

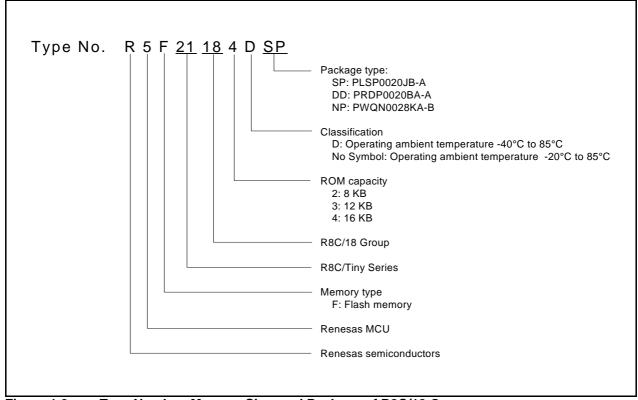


Figure 1.2 Type Number, Memory Size, and Package of R8C/18 Group

Table 1.4 Product Information for R8C/19 Group

Current of Apr. 2006

Type No.	ROM C	apacity	RAM	Packago Typo	Remarks
Type No.	Program ROM	Data flash	Capacity	Package Type	Remarks
R5F21191SP	4 Kbytes	1 Kbyte x 2	384 bytes	PLSP0020JB-A	Flash memory version
R5F21192SP	8 Kbytes	1 Kbyte × 2	512 bytes	PLSP0020JB-A	
R5F21193SP	12 Kbytes	1 Kbyte × 2	768 bytes	PLSP0020JB-A	
R5F21194SP	16 Kbytes	1 Kbyte × 2	1 Kbyte	PLSP0020JB-A	
R5F21191DSP (D)	4 Kbytes	1 Kbyte × 2	384 bytes	PLSP0020JB-A	D version
R5F21192DSP (D)	8 Kbytes	1 Kbyte × 2	512 bytes	PLSP0020JB-A	
R5F21193DSP (D)	12 Kbytes	1 Kbyte x 2	768 bytes	PLSP0020JB-A	
R5F21194DSP (D)	16 Kbytes	1 Kbyte × 2	1 Kbyte	PLSP0020JB-A	
R5F21191DD	4 Kbytes	1 Kbyte × 2	384 bytes	PRDP0020BA-A	Flash memory version
R5F21192DD	8 Kbytes	1 Kbyte × 2	512 bytes	PRDP0020BA-A	
R5F21193DD	12 Kbytes	1 Kbyte x 2	768 bytes	PRDP0020BA-A	
R5F21194DD	16 Kbytes	1 Kbyte × 2	1 Kbyte	PRDP0020BA-A	
R5F21192NP	8 Kbytes	1 Kbyte x 2	512 bytes	PWQN0028KA-B	Flash memory version
R5F21193NP	12 Kbytes	1 Kbyte × 2	768 bytes	PWQN0028KA-B	
R5F21194NP	16 Kbytes	1 Kbyte × 2	1 Kbyte	PWQN0028KA-B	

(D): Under Development

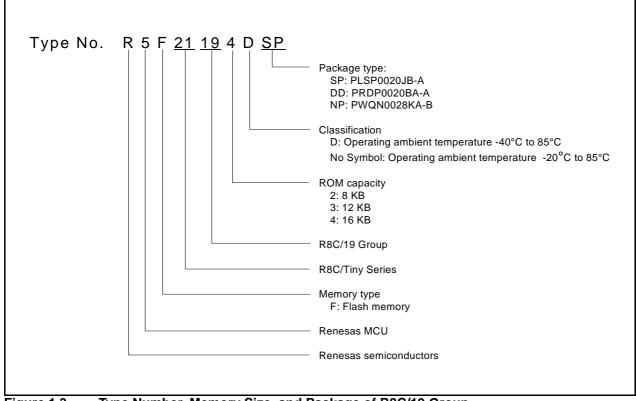


Figure 1.3 Type Number, Memory Size, and Package of R8C/19 Group

1.5 Pin Assignments

Figure 1.4 shows Pin Assignments for PLSP0020JB-A Package (Top View), Figure 1.5 shows Pin Assignments for PRDP0020BA-A Package (Top View) and Figure 1.6 shows Pin Assignments for PWQN0028KA-B Package (Top View).

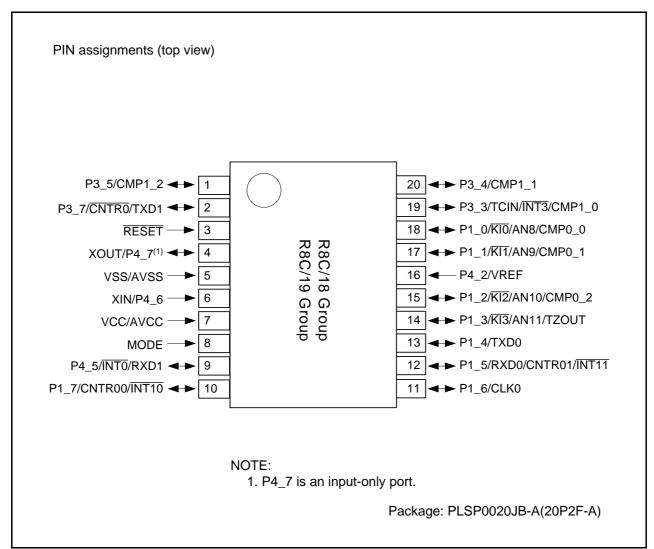


Figure 1.4 Pin Assignments for PLSP0020JB-A Package (Top View)

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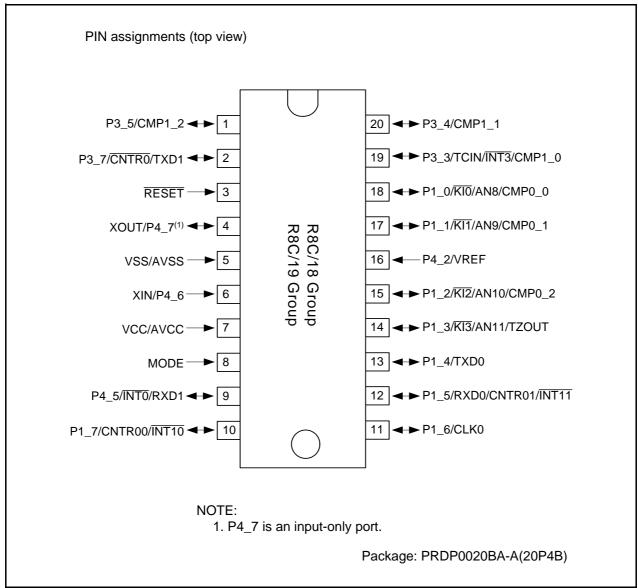


Figure 1.5 Pin Assignments for PRDP0020BA-A Package (Top View)

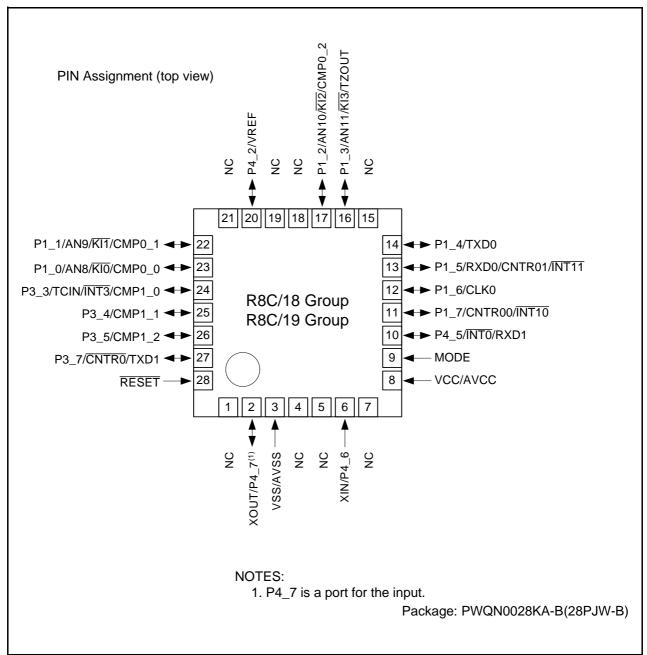


Figure 1.6 Pin Assignments for PWQN0028KA-B Package (Top View)

1.6 Pin Functions

Table 1.5 lists Pin Functions, Table 1.6 lists Pin Name Information by Pin Number of PLSP0020JB-A, PRDP0020BA-A packages, and Table 1.7 lists Pin Name Information by Pin Number of PWQN0028KA-B package.

Table 1.5 Pin Functions

Туре	Symbol	I/O Type	Description
Power supply input	VCC VSS	I	Apply 2.7 V to 5.5 V to the VCC pin. Apply 0 V to the VSS pin.
Analog power supply input	AVCC, AVSS	I	Power supply for the comparator Connect a capacitor between AVCC and AVSS.
Reset input	RESET	I	Input "L" on this pin resets the MCU.
MODE	MODE	I	Connect this pin to VCC via a resistor.
Main clock input	XIN	I	These pins are provided for main clock generation circuit I/O. Connect a ceramic resonator or a crystal oscillator between the XIN and XOUT pins.
Main clock output	XOUT	0	To use an external clock, input it to the XIN pin and leave the XOUT pin open.
INT interrupt	INTO, INT1, INT3	I	INT interrupt input pins
Key input interrupt	KI0 to KI3	I	Key input interrupt input pins
Timer X	CNTR0	I/O	Timer X I/O pin
	CNTR0	0	Timer X output pin
Timer Z	TZOUT	0	Timer Z output pin
Timer C	TCIN	I	Timer C input pin
	CMP0_0 to CMP0_2, CMP1_0 to CMP1_2	0	Timer C output pins
Serial interface	CLK0	I/O	Transfer clock I/O pin
	RXD0, RXD1	I	Serial data input pins
	TXD0, TXD1	0	Serial data output pins
Reference voltage input	VREF	I	Reference voltage input pin to comparator
Comparator	AN8 to AN11	I	Analog input pins to comparator
I/O port	P1_0 to P1_7, P3_3 to P3_5, P3_7, P4_5	I/O	CMOS I/O ports. Each port has an I/O select direction register, allowing each pin in the port to be directed for input or output individually. Any port set to input can be set to use a pull-up resistor or not by a program. P1_0 to P1_3 also function as LED drive ports.
Input port	P4_2, P4_6, P4_7	I	Input-only ports

I: Input O: Output

I/O: Input and output

Pin Name Information by Pin Number of PLSP0020JB-A, PRDP0020BA-A packages Table 1.6

Pin	Control	Port	I/C	Pin Functions for	r Peripheral Modul	es
Number	Pin	FUIL	Interrupt	Timer	Serial Interface	Comparator
1		P3_5		CMP1_2		
2		P3_7		CNTR0	TXD1	
3	RESET					
4	XOUT	P4_7				
5	VSS/AVSS					
6	XIN	P4_6				
7	VCC/AVCC					
8	MODE					
9		P4_5	ĪNT0		RXD1	
10		P1_7	ĪNT10	CNTR00		
11		P1_6			CLK0	
12		P1_5	ĪNT11	CNTR01	RXD0	
13		P1_4			TXD0	
14		P1_3	KI3	TZOUT		AN11
15		P1_2	KI2	CMP0_2		AN10
16	VREF	P4_2				
17		P1_1	KI1	CMP0_1		AN9
18		P1_0	KI0	CMP0_0		AN8
19		P3_3	ĪNT3	TCIN/CMP1_0		
20		P3_4		CMP1_1		

Table 1.7 Pin Name Information by Pin Number of PWQN0028KA-B package

Pin	Control	Port		I/O Pin of Perip	oheral Function	
Number	Pin	Port	Interrupt	Timer	Serial Interface	Comparator
1	NC					
2	XOUT	P4_7				
3	VSS/AVSS					
4	NC					
5	NC					
6	XIN	P4_6				
7	NC					
8	VCC/AVCC					
9	MODE					
10		P4_5	ĪNT0		RXD1	
11		P1_7	ĪNT10	CNTR00		
12		P1_6			CLK0	
13		P1_5	ĪNT11	CNTR01	RXD0	
14		P1_4			TXD0	
15	NC					
16		P1_3	KI3	TZOUT		AN11
17		P1_2	KI2	CMP0_2		AN10
18	NC					
19	NC					
20	VREF	P4_2				
21	NC					
22		P1_1	KI1	CMP0_1		AN9
23		P1_0	KI0	CMP0_0		AN8
24		P3_3	ĪNT3	TCIN/CMP1_0		
25		P3_4		CMP1_1		
26		P3_5		CMP1_2		
27		P3_7		CNTR0	TXD1	
28	RESET					

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.

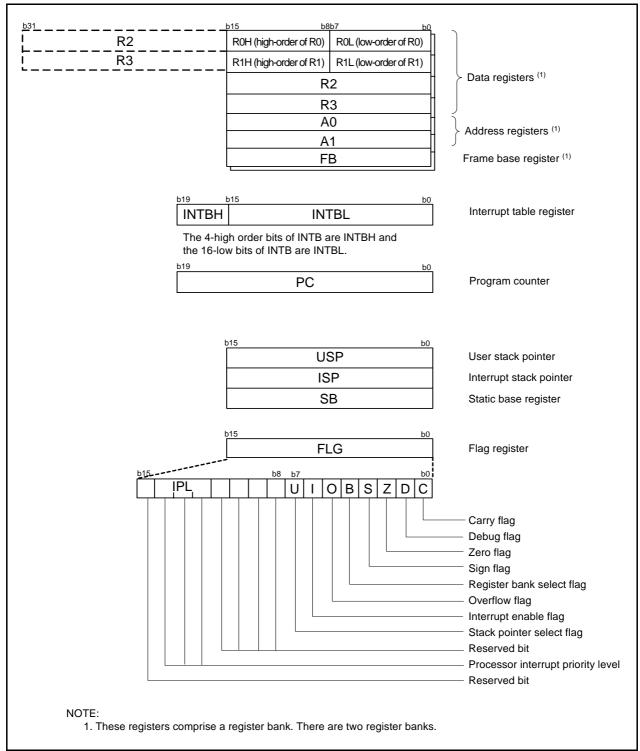


Figure 2.1 CPU Registers

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2.1 Data Registers (R0, R1, R2, and R3)

R0 is a 16-bit register for transfer, arithmetic, and logic operations. The same applies to R1 to R3. R0 can be split into high-order bits (R0H) and low-order bits (R0L) to be used separately as 8-bit data registers. R1H and R1L are analogous to R0H and R0L. R2 can be combined with R0 and used as a 32-bit data register (R2R0). R3R1 is analogous to R2R0.

2.2 Address Registers (A0 and A1)

A0 is a 16-bit register for address register indirect addressing and address register relative addressing. It is also used for transfer, arithmetic and logic operations. A1 is analogous to A0. A1 can be combined with A0 and used as a 32-bit address register (A1A0).

2.3 Frame Base Register (FB)

FB is a 16-bit register for FB relative addressing.

2.4 Interrupt Table Register (INTB)

INTB is a 20-bit register that indicates the start address of an interrupt vector table.

2.5 Program Counter (PC)

PC is 20 bits wide, indicates the address of the next instruction to be executed.

2.6 User Stack Pointer (USP) and Interrupt Stack Pointer (ISP)

The stack pointer (SP), USP, and ISP, are each 16 bits wide. The U flag of FLG is used to switch between USP and ISP.

2.7 Static Base Register (SB)

SB is a 16-bit register for SB relative addressing.

2.8 Flag Register (FLG)

FLG is an 11-bit register indicating the CPU state.

2.8.1 Carry Flag (C)

The C flag retains a carry, borrow, or shift-out bits that have been generated by the arithmetic and logic unit.

2.8.2 Debug Flag (D)

The D flag is for debugging only. Set it to 0.

2.8.3 **Zero Flag (Z)**

The Z flag is set to 1 when an arithmetic operation results in 0; otherwise to 0.

2.8.4 **Sign Flag (S)**

The S flag is set to 1 when an arithmetic operation results in a negative value; otherwise to 0.

2.8.5 Register Bank Select Flag (B)

Register bank 0 is selected when the B flag is 0. Register bank 1 is selected when this flag is set to 1.

2.8.6 Overflow Flag (O)

The O flag is set to 1 when the operation results in an overflow; otherwise to 0.



2.8.7 Interrupt Enable Flag (I)

The I flag enables maskable interrupts.

Interrupts are disabled when the I flag is set to 0, and are enabled when the I flag is set to 1. The I flag is set to 0 when an interrupt request is acknowledged.

2.8.8 Stack Pointer Select Flag (U)

ISP is selected when the U flag is set to 0; USP is selected when the U flag is set to 1.

The U flag is set to 0 when a hardware interrupt request is acknowledged or the INT instruction of software interrupt numbers 0 to 31 is executed.

2.8.9 Processor Interrupt Priority Level (IPL)

IPL is 3 bits wide, assigns processor interrupt priority levels from level 0 to level 7. If a requested interrupt has higher priority than IPL, the interrupt is enabled.

2.8.10 Reserved Bit

If necessary, set to 0. When read, the content is undefined.



3. Memory

3.1 R8C/18 Group

Figure 3.1 is a Memory Map of R8C/18 Group. The R8C/18 Group has 1 Mbyte of address space from addresses 00000h to FFFFFh.

The internal ROM area is allocated lower addresses, beginning with address 0FFFFh. For example, a 16-Kbyte internal ROM is allocated addresses 0C000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 1-Kbyte internal RAM area is allocated addresses 00400h to 007FFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFRs) are allocated addresses 00000h to 002FFh. The peripheral function control registers are allocated here. All addresses within the SFR, which have nothing allocated are reserved for future use and cannot be accessed by users.

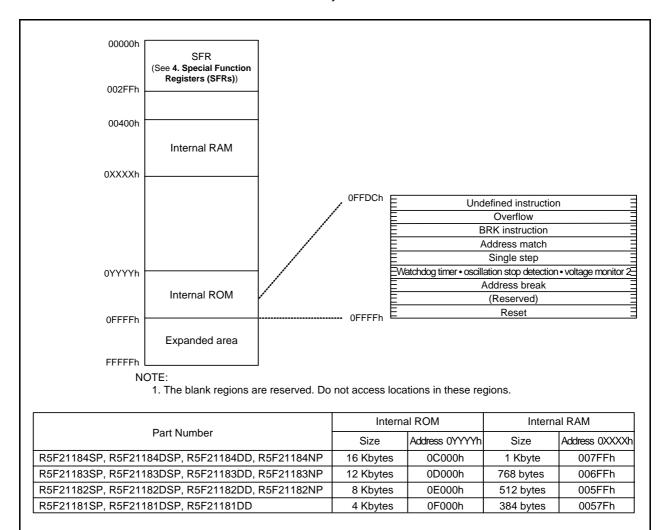


Figure 3.1 Memory Map of R8C/18 Group

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3.2 R8C/19 Group

Figure 3.2 is a Memory Map of R8C/19 Group. The R8C/19 group has 1 Mbyte of address space from addresses 00000h to FFFFFh.

The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFh. For example, a 16-Kbyte internal ROM area is allocated addresses 0C000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal ROM (data flash) is allocated addresses 02400h to 02BFFh.

The internal RAM is allocated higher addresses, beginning with address 00400h. For example, a 1-Kbyte internal RAM area is allocated addresses 00400h to 007FFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFRs) are allocated addresses 00000h to 002FFh. The peripheral function control registers are allocated here. All addresses within the SFR, which have nothing allocated are reserved for future use and cannot be accessed by users.

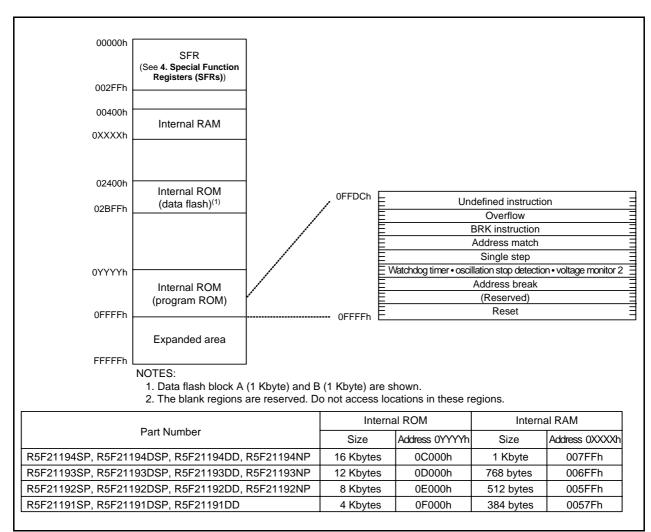


Figure 3.2 Memory Map of R8C/19 Group

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4. Special Function Registers (SFRs)

An SFR (special function register) is a control register for a peripheral function. Tables 4.1 to 4.4 list the special function registers.

Table 4.1 SFR Information (1)⁽¹⁾

Address	Register	Symbol	After reset
0000h	rvegistei	Syllibol	Alter reset
0000h			
0001h			
0002H			
	Draggagy Mada Dagistar O	PM0	006
	Processor Mode Register 0		00h
	Processor Mode Register 1	PM1	00h
0006h	System Clock Control Register 0	CM0	01101000b
	System Clock Control Register 1	CM1	00100000b
0008h			
	Address Match Interrupt Enable Register	AIER	00h
	Protect Register	PRCR	00h
000Bh			
	Oscillation Stop Detection Register	OCD	00000100b
000Dh	Watchdog Timer Reset Register	WDTR	XXh
000Eh	Watchdog Timer Start Register	WDTS	XXh
000Fh	Watchdog Timer Control Register	WDC	00011111b
0010h	Address Match Interrupt Register 0	RMAD0	00h
0011h			00h
0012h			X0h
0012h			7.0
	Address Match Interrupt Register 1	RMAD1	00h
0014II 0015h	Address mater interrupt register 1	KIVIAD I	00h
0016h			X0h
0017h			
0018h			
0019h			
001Ah			
001Bh			
	Count Source Protection Mode Register	CSPR	00h
001Dh			
001Eh	INT0 Input Filter Select Register	INT0F	00h
001Fh	THE INDICE THE COLOUR PROJECT		
	High-Speed On-Chip Oscillator Control Register 0	HRA0	00h
	High-Speed On-Chip Oscillator Control Register 1	HRA1	
002111 0022h	High-Speed On-Chip Oscillator Control Register 2	HRA2	When shipping 00h
	High-Speed On-Chip Oscillator Control Register 2	HRA2	oon
0023h			
002Ah			
002Bh			
002Ch			
002Dh			
002Eh			
002Fh			
0030h			
	Voltage Detection Register 1 ⁽²⁾	VCA1	00001000b
	Voltage Detection Register 2 ⁽²⁾	VCA2	00h ⁽³⁾
	Takaga Datoolion Rogiotol E. /		01000000b ⁽⁴⁾
00335			01000000000
0033h			
0034h			
0035h			
0036h	Voltage Monitor 1 Circuit Control Register (2)	VW1C	0000X000b ⁽³⁾
			0100X001b ⁽⁴⁾
0037h	Voltage Monitor 2 Circuit Control Register (5)	VW2C	00h
0038h	5 .0		
0039h			
0033H			
003An			
003Ch			
003Dh			
003Eh 003Fh			
			1

X: Undefined

- 1. The blank regions are reserved. Do not access locations in these regions.
- 2. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect this register.
- 3. After hardware reset.
- 4. After power-on reset or voltage monitor 1 reset.
- 5. Software reset, watchdog timer reset, and voltage monitor 2 reset do not affect b2 and b3.



SFR Information (2)⁽¹⁾ Table 4.2

Address	Register	Symbol	After reset
0040h	5	,	
0041h			
0042h			
0043h			
0044h			
0045h			
0046h			
0047h			
0048h			
0049h			
004Ah			
004Bh			
004Ch			
004Dh	Key Input Interrupt Control Register	KUPIC	XXXXX000b
004Eh	Comparator Conversion Interrupt Control Register	ADIC	XXXXX000b
004Fh			
0050h	Compare 1 Interrupt Control Register	CMP1IC	XXXXX000b
0051h	UARTO Transmit Interrupt Control Register	SOTIC	XXXXX000b
0052h	UARTO Receive Interrupt Control Register	SORIC	XXXXX000b
0053h	UART1 Transmit Interrupt Control Register	S1TIC	XXXXX000b
0054h	UART1 Receive Interrupt Control Register	S1RIC	XXXXX000b
0055h	Timor V Interrupt Central Pagister	TVIC	VVVVV000h
0056h 0057h	Timer X Interrupt Control Register	TXIC	XXXXX000b
0057h 0058h	Timer Z Interrupt Control Register	TZIC	XXXXX000b
0059h	-	INT1IC	XXXXX000b
	INT1 Interrupt Control Register		
005Ah	INT3 Interrupt Control Register	INT3IC	XXXXX000b
005Bh	Timer C Interrupt Control Register	TCIC	XXXXX000b
005Ch	Compare 0 Interrupt Control Register	CMP0IC	XXXXX000b
005Dh	INTO Interrupt Control Register	INT0IC	XX00X000b
005Eh			
005Fh			
0060h			
0061h			
0062h			
0063h			
0064h			
0065h			
0066h			
0067h 0068h			
0069h			
006Ah			
006Bh			
006Ch			
006Dh			
006Eh			
006Fh			
0070h			
0071h			
0072h			
0073h			
0074h			
0075h			
0076h			
0077h			
0078h			
0079h			
007Ah			
007Bh			
007Ch			
007Dh			
007Eh			
007Fh			

X: Undefined

NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

SFR Information (3)⁽¹⁾ Table 4.3

Address	Register	Symbol	After reset
0080h	Timer Z Mode Register	TZMR	00h
0080h	Tiller 2 Wode Register	1 ZIVII (0011
0081h			
0083h			
0084h	Timer Z Waveform Output Control Register	PUM	00h
0085h	Prescaler Z Register	PREZ	FFh
	Timer Z Secondary Register	TZSC	
0086h	Timer Z Primary Register	TZPR	FFh
0087h	Timer Z Primary Register	IZPR	FFh
0088h			
0089h	T. 70	T700	001
008Ah	Timer Z Output Control Register	TZOC	00h
008Bh	Timer X Mode Register	TXMR	00h
008Ch	Prescaler X Register	PREX	FFh
008Dh	Timer X Register	TX	FFh
008Eh	Timer Count Source Setting Register	TCSS	00h
008Fh			
0090h	Timer C Register	TC	00h
0091h			00h
0092h			
0093h			
0094h			
0095h			
0096h	External Input Enable Register	INTEN	00h
0097h	-		
0098h	Key Input Enable Register	KIEN	00h
0099h			
009Ah	Timer C Control Register 0	TCC0	00h
009Bh	Timer C Control Register 1	TCC1	00h
009Ch	Capture, Compare 0 Register	TMO	00h
009Dh	-		00h(2)
009Eh	Compare 1 Register	TM1	FFh
009Eh	Compare i Register	TIVIT	FFh
009FII	LIADTO Transmit/Passiva Mada Pagistor	UOMR	00h
00A011	UARTO Transmit/Receive Mode Register	U0BRG	XXh
	UARTO Bit Rate Register		
00A2h	UART0 Transmit Buffer Register	U0TB	XXh
00A3h	1110707		XXh
00A4h	UART0 Transmit/Receive Control Register 0	U0C0	00001000b
00A5h	UART0 Transmit/Receive Control Register 1	U0C1	00000010b
00A6h	UART0 Receive Buffer Register	U0RB	XXh
00A7h			XXh
00A8h	UART1 Transmit/Receive Mode Register	U1MR	00h
00A9h	UART1 Bit Rate Register	U1BRG	XXh
00AAh	UART1 Transmit Buffer Register	U1TB	XXh
00ABh			XXh
00ACh	UART1 Transmit/Receive Control Register 0	U1C0	00001000b
00ADh	UART1 Transmit/Receive Control Register 1	U1C1	00000010b
00AEh	UART1 Receive Buffer Register	U1RB	XXh
00AFh			XXh
00B0h	UART Transmit/Receive Control Register 2	UCON	00h
00B1h			
00B2h			
00B3h			
00B4h			
00B5h			1
00B6h			
00B7h			
00B8h			
00B9h			
00BAh			1
00BBh			
00BCh			1
00BDh			
00BEh			
UUDLII			
00BFh			

X: Undefined NOTES:

- The blank regions are reserved. Do not access locations in these regions.
 When the output compare mode is selected (the TCC13 bit in the TCC1 register = 1), the value is set to FFFF16.

SFR Information (4)⁽¹⁾ Table 4.4

DOCCOR	Address	Register	Symbol	After reset
0002h 0003h 0003	00C0h			
9003h				
00C4h 00C8h 00C8h 00C8h 00C7h 00C7h 00C7h 00C7h 00C2h 00C7h 00C2h 00C7h 00C7h 00C7h 00C7h 00C7h 00D9h 00D9h 00D9h <td></td> <td></td> <td></td> <td></td>				
0005h				
000C6h	00C4h			
00C7h 00C8h 00C8h 00C8h 00D0h 00D0h 00D1h 00D0h 00D2h AD Control Register 0 00D5h 00D0h 00D7h AD Control Register 0 00D8h 00D0h 00D8h 00D0h 00D8h 00D0h 00D8h 00D0h 00D0h 00D0h 00D0h 00D0h 00E0h 00D0h 00E0h 00C8h 00E3h 00F1 Port P3 Register 00E3h Port P1 Register 00E3h Port P3 Register 00E3h Port P3 Register 00E3h Port P3 Port P3 Register 00E4h 00E5h 00E5h Port P3 Registe				
0005h 0005				
0005h 0006h 0006				
00Cbh 00Cbh 00Cbh 00Cbh 00Cbh 00Cbh 00Cbh 00Cbh 00D0bh 00D0bh 00D2h 00D3h 00D3h AD Control Register 2 00D6h ADCON0 00D8h AD Control Register 0 00D8h ADCON1 00D8h ADCON1 00D8h ADCON1 00D8h ADCON1 00D8h ADCON1 00D8h ADCON1 00D8h ODCh 00Eh Port P1 Register 00Eh Port P2 Register 00Eh Port P3 Direction Register 00Eh Port P3 Direction Register	00C9h			
00CCh 00CEh 00CCh 00CEh 00CCh 00CH 00D0h 00D0h 00D1h 00D1h 00D3h 00D3h 00D3h AD Control Register 2 00D4h AD Control Register 1 00D4h AD Control Register 1 00D7h AD Control Register 1 00D4h AD CON1 00D4h 00D8h 00D4h 00D8h 00D4h 00D8h 00D4h 00D8h 00D4h 00D8h 00D4h 00D8h 00D5h 00D8h 00D6h 00D8h 00E0h 00D8h 00E1h 00E2h 00E2h 00E3h 00E3h Port P1 Direction Register 00E4h Port P3 Register P3 00E4h Port P4 Register P4 00E4h Port P4 Register P4 00E4h Port P4 Direction Register PD3 00E6h Port P4 Direction Regist				
000Cbh 00CFh 00Cbh 00CPh 00Cbh 00Ch 00Dlah 00Dlah 00Dlah AD Control Register 2 00Dsh AD Control Register 0 00Dsh AD Control Register 1 00Dbh AD Control Register 1 00Dsh AD Control Register 1 00Dsh ADCON1 00Dsh 00Dsh 00Esh 00Esh 00Esh Port P1 Direction Register 00Esh Port P3 Direction Register 00Esh Port P4 Register 00Esh Port P4 Register 00Esh Port P5 Direction Register 00Esh Port P5 Dir				
00CEh 00Ch 00DOh 00DOh 00D1h 00D3h 00D3h 00D3h 00D3h AD Control Register 2 00D3h AD Control Register 1 00D4h AD COND 00D4h AD COND 00D4h 00DAn 00D4h 00DAn 00D4h 00DAn 00D4h 00DAn 00D5h 00DAn 00D4h 00DAn 00D5h 00DAn 00E3h 00FD 00E3h Pot P3 Register 00E4h 00E3h 00E5h Pot P3 Direction Register P3 00E4h 00E3h 00E4h 00E3h 00E4h 00E3h				
00CPh 00D0h 00D1h 00D1h 00D2h 00D0h 00D3h AD Control Register 2 00h 00D3h AD Control Register 0 00000h 00D3h AD Control Register 1 00h 00D3h AD Control Register 1 00h 00D3h 00D3h 00h 00D4h 00D4h 00h 00D4h 00D4h 00h 00D5h 00D6h 00h 00D6h 00D6h 00h 00D6h 00D6h 00h 00D6h 00D6h 00h 00E3h 00Fh 00h 00E3h Port P1 Register P1 XXh 00E3h Port P3 Register P3 XXh 00E3h Port P3 Register P3 00h 00E3h Port P3 Register P4 XXh 00E3h Port P4 Direction Register P3 00h 00E4h Port P3 Direction Register P4 00h 00E4h Port				
00010h				
00D1h 00D2h 00D2h 0D0h 00D3h AD Control Register 2 ADCON2 00h 00D5h AD Control Register 0 ADCON0 000000XXb 00D7h AD Control Register 1 ADCON1 00h 00D8h 00D0h 00h 00h 00D8h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D0h 00D2h 00D0h 00D0h 00D0h 00D2h 00D0h 00D0h 00D0h 00E3h Port P1 Register P1 XXh 00E3h Port P3 Register P3 XXh 00E3h Port P3 Register P3 XXh 00E3h Port P4 Direction Register P3 00h 00E3h Port P4 Direction Register P4 00h 00E4h <t< td=""><td></td><td></td><td></td><td></td></t<>				
00D2h 00D4h AD Control Register 2 ADCON2 00h 00D4h AD Control Register 0 ADCON0 000000000000000000000000000000000000				
00D4h AD Control Register 2 ADCON2 00h 00D5h AD Control Register 0 ADCON0 000000XXXb 00D7h AD Control Register 1 ADCON1 00h 00D8h 00D8h 00DA 00DA 00D8h 00DA 00DA 00DA 00D5h 00DBh 00DBh 00DBh 00D5h 00DBh 00DBh 00DBh 00D5h 00DBh 00DBh 00DBh 00D6h 00DBh 00DBh 00DBh 00E3h Port P1 Register P1 XXh 00E3h Port P2 Bregister P3 XXh 00E4h P0T P3 Register P3 XXh 00E4h P0T P4 Register P4 XXh 00E8h P0T P4 Register				
00D4h AD Control Register 2 ADCON2 00h 00D5h AD Control Register 0 ADCON0 000000XXXb 00D7h AD Control Register 1 ADCON1 00h 00D8h 00D8h 00DA 00DA 00D8h 00DA 00DA 00DA 00D5h 00DBh 00DBh 00DBh 00D5h 00DBh 00DBh 00DBh 00D5h 00DBh 00DBh 00DBh 00D6h 00DBh 00DBh 00DBh 00E3h Port P1 Register P1 XXh 00E3h Port P2 Bregister P3 XXh 00E4h P0T P3 Register P3 XXh 00E4h P0T P4 Register P4 XXh 00E8h P0T P4 Register	00D3h			
00D6h A/D Control Register 0 ADCON0 00000XXXb 00D7h A/D Control Register 1 ADCON1 000h 00D8h 00DAh 00DAh 00DAh 00DBh 00DBh 00DBh 00DBh 00DCh 00DCh 00DCh 00DBh 00DDh 00DBh 00DBh 00DBh 00DFh 00DFh 00DBh 00DBh 00E1h 00E1h 00DBh 00DBh 00E2h 00E3h 00E3h 00DBh 00E3h Port P1 Direction Register PD1 00h 00E4h 00E3h Port P3 Register P3 XXh 00E6h 00E7h 00H 00E8h 00H 00E8h Port P4 Register P4 XXh 00E8h Port P4 Direction Register PD4 00h 00E8h 00E0h 00H 00H 00E8h 00E0h 00H 00H 00E0h 00E0h 00H 00H 00E0h <t< td=""><td>00D4h</td><td>A/D Control Register 2</td><td>ADCON2</td><td>00h</td></t<>	00D4h	A/D Control Register 2	ADCON2	00h
00DRh A/D Control Register 1 00h 00D8h 00D9h 00DAh 00DBh 00DCh 00DCh 00DCh 00DCh 00DEh 00DEh 00Eh 00Eh 00Eh <t< td=""><td></td><td></td><td></td><td></td></t<>				
00D8h 00DAh 00DAh 00DAh 00DBh 00DCh 00DDh 00DDh 00DDh 00DDh 00DFh 00DFh 00DFh 00DFh 00E1h Port P1 Register 00E2h 00E3h 00E3h Port P1 Direction Register 00E3h Port P2 Breston Register 00E6h Port P3 Direction Register 00E8h Port P4 Register 00E8h Port P4 Direction Register 00E8h Port P4 Direction Register 00E8h Port P5 Direction Register 00E8h Port P6 Direction Register 00E8h Port P7 Direction Register 00E8h Port P8 Direction Register 00E2h Oberth 00E2h Oberth 00E2h Oberth 00E2h Oberth 00E2h Oberth 00F3h Oberth 00F4h Oberth 00F5h Oberth 00F6h Oberth <t< td=""><td>00D6h</td><td>A/D Control Register 0</td><td>ADCON0</td><td></td></t<>	00D6h	A/D Control Register 0	ADCON0	
00D9h 00DBh 00DBh 00DBh 00DCh 00DCh 00DEh 00DEh 00DFh 00DFh 00E1h 00E1h 00E2h 00E3h 00E3h Port P1 Direction Register 00E3h Port P2 Direction Register 00E3h Port P3 Register 00E6h Port P4 Register 00E7h Port P4 Register 00E8h Port P4 Register 00E8h Port P4 Register 00E8h Port P4 Direction Register 00E8h Port P4 Direction Register 00E8h Port P4 Direction Register 00E8h Port P5 P4 Direction Register 00E8h Port P6 Register 00E9h Port P6 Register 00E9h Port P6 Register 00E9h Port P7 Register 00E9h Port P8 Register 00F8h Port P8 Register 00F8h Port P8 Register 00F8h Port P8 Register 00F8h Port P8 Register <t< td=""><td></td><td>A/D Control Register 1</td><td>ADCON1</td><td>uun</td></t<>		A/D Control Register 1	ADCON1	uun
00DAh 00DBh 00DCh 00DCh 00DDh 00DBh 00DFh 00DFh 00E1h 00E1h 00E1h 00E1h 00E1h 00E1h 00E3h 00E3h 00E3h Port P1 Direction Register 00E3h Port P2 Register 00E6h Port P3 Direction Register 00E8h Port P4 Register 00E8h Port P4 Register 00E8h Port P4 Direction Register 00E9h Ooh 00E1h Ooh 00E2h Ooh 00E2h Ooh 00E2h Ooh 00E3h Ooh 00F8h Ooh 00F8h Ooh 00F8h Ooh 00F8h <				
00DBh 00DCh 00DCh 00DDh 00DFh 00E0h 00E0h 00E1h 00E2h 00E2h 00E2h 00E2h 00E2h 00E2h 00E3h Port P1 Direction Register 00E3h Port P3 Register 00E5h Port P3 Direction Register 00E7h Port P4 Register 00E8h Port P4 Register 00E8h Port P4 Direction Register 00E8h Port P4 Direction Register 00E8h Pot P4 Direction Register 00EBh Do 00ECh 00E0h 00EDh 00E0h 00E7h 00F0h 00E7h 00F3h 00F3h 00F4h 00F3h 00F3h 00F6h 00F6h 00F7h 00F8h 00F8h 00F8h 00F9h 00F9h 00F9h 00F9h 00F9h 00F9h 00F9h 00F9h 00F9	00D9H			
OODCh OODED OODEN O				
OODDh OODEh OODEh OOED OOE1h OOE2h OOE3h OOE3h OOE3h OOE5h OOE5h OOE5h OOE6h OOE7h OOE7h OOE7h OOE7h OOE9h OOF9h OO				
00DFh 00E1h Port P1 Register P1 XXh 00E2h 00E3h Port P1 Direction Register PD1 00h 00E3h Port P3 Register P3 XXh 00E6h 00E7h Port P3 Direction Register PD3 00h 00E8h Port P4 Register P4 XXh 00E9h P0 XXh 00E0 00EAh P0rt P4 Direction Register PD4 00h 00EBh P0rt P4 Direction Register PD4 00h 00EDh 00E0h 00h 00h 00ECh 00EDh 00h 00h 00EFh 00Fh 00Fh 00Fh 00F1h 00Fh 00Fh 00Fh 00F3h 00Fh 00Fh 00Fh 00F3h 00Fh 00Fh 00Fh 00F3h 00Fh 00Fh 00Fh 00F9h 00Fh 00Fh 00Fh 00Fh 00F9h 00Fh 00Fh 00Fh 00Fh	00DDh			
00E1h 00E3h Port P1 Register P1 XXh 00E3h 00E3h Port P1 Direction Register PD1 00h 00E4h 00E5h P0T P3 Register P3 XXh 00E6h 00E7h Port P3 Direction Register PD3 00h 00E8h 00E8h 00E8h P0rt P4 Register P4 XXh 00E9h 00E9h 00E0h P0rt P4 Direction Register PD4 00h 00E8h 00ECh 00E0h P0rt P4 Direction Register PD4 00h 00E9h 00E0h 00E0h 00E0h P0rt P4 Direction Register PD4 00h 00E1h 00E0h 00E0h 00E0h P0rt P4 Direction Register PD4 00h 00E1h 00F2h 00F3h 00F4h P0rt P4 Direction Register PD4 00h 00F3h 00F6h 00F6h 00F6h 00F6h P0rt P4 Direction Register 0 P0rt P4 Direction Register 0 P0rt P4 Direction Register 0 00F8h 00F6h 00F6h P0rt P4 Direction Register 0 PUR0 00XX0000b 00XX0000b 00F1h 00F6h P0rt P4 Direction Register 0 PUR0 00XX0000b 00R Direction Register 0 00F1h 00F6h P0rt P1 Dirive Capacity Control Register 0 PUR0 00XXX000b 00h	00DEh			
00E1h ODE2h Port PR Register P1 XXh 00E2h ODE3h Port P1 Direction Register PD1 00h 00E4h ODE6h P0rt P3 Register P3 XXh 00E6h ODE7h Port P3 Direction Register PD3 00h 00E8h P0rt P4 Register P4 XXh 00E9h ODE8h P0rt P4 Direction Register PD4 00h 00EAh P0rt P4 Direction Register PD4 00h 00ED P1 P0F1 P4 Direction Register PD4 00h 00ED P1 PD4 00h 00h 00ED P2 P0F2 00h				
00E2h 00E3h Port P1 Direction Register PD1 00h 00E4h Port P3 Register P3 XXh 00E6h Port P3 Direction Register PD3 00h 00E8h Port P4 Register P4 XXh 00E9h 00E0h 00h 00h 00E8h Port P4 Direction Register PD4 00h 00E0h 00E0h 00h 00h 00E0h 00E0h 00h 00h 00E0h 00E0h 00h 00h 00E0h 00E0h 00h 00h 00E1h 00E0h 00H 00H 00E2h 00E0h 00E0h 00E0h 00E1h 00E1h 00E1h 00E1h 00E2h 00E2h 00E2h 00E2h 00E3h 00E3h 00E3h 00E3h 00E4h 00E3h 00E3h 00E3h 00F3h 00F3h 00E3h 00E3h 00F3h 00F3h 00E3h 00E3h				V. 7.
00E3h Port P1 Direction Register PD1 00h 00E4h Port P3 Register P3 XXh 00E7h Port P3 Direction Register PD3 00h 00E8h Port P4 Register P4 XXh 00E9h P0t P0t P0t 00EAh Port P4 Direction Register PD4 00h 00EBh 00ECh 00ED 00h 00ECh 00EDh 00EDh 00EDh 00EFh 00EFh 00EHh 00Fh 00Fh 00Fh		Port P1 Register	P1	XXh
00E4h 00E6h Port P3 Register P3 XXh 00E6h Port P4 Direction Register PD3 00h 00E8h P0T P4 Register P4 XXh 00E9h 00E0h 00h 00E8h 00h 00h 00EBh 00h 00h 00EDh 00EDh 00h 00EBh 00EDh 00EDh 00EBh 00EDh 00EDh 00EBh 00F0h 00EDh 00EPh 00F0h 00EDh 00F3h 00F3h 00F3h 00F4h 00F3h 00F3h 00F4h 00F3h 00F3h	00E2h	Dort D1 Direction Register	DD4	00h
00E6h Port P3 Register 00E6h Port P3 Direction Register 00E7h Port P4 Register 00E8h Port P4 Register 00E9h Port P4 Direction Register 00EAh Port P4 Direction Register 00EBh O0 00ECh O0 00ECh O0EDh 00ECh O0EDh 00ECh O0ERH 00E7h O0Foh 00F1h O0Foh 00F2h O0Foh 00F3h O0Foh 00F6h O0Foh 00F6h O0Foh 00F6h O0Foh 00F8h O0Foh 00F8h O0Foh 00F8h O0Foh 00F9h O0Foh 00F0h Pull-Up Control Register 0 00F0h Pull-Up Control Register 1 00F0h Pull P1 Dive Capacity Control Register Doh 00Feh O0h 00Feh O0h O0h 00FFh O0h O0h </td <td></td> <td> Fort F1 Direction Register</td> <td>וטיו</td> <td>OOT</td>		Fort F1 Direction Register	וטיו	OOT
00E6h DOETh Port P3 Direction Register PD3 00h 00E8h Port P4 Register P4 XXh 00E8h 00EAh PD4 00h 00EBh 00 00 00 00EDh 00EBh 00 00 00EDh 00EBh 00 00 00EBh 00Fbh 00 00 00 00Eh 00Eh 00 </td <td></td> <td>L Port P3 Register</td> <td>P3</td> <td>XXh</td>		L Port P3 Register	P3	XXh
00E7h Port P3 Direction Register P9 00h 00E8h Port P4 Register P4 XXh 00E9h ODEAh Port P4 Direction Register PD4 ODh 00EBh ODECh ODH ODh 00ECh ODECH ODECH ODECH 00EFh ODECH ODECH ODECH 00F1h ODF3h ODECH ODECH 00F3h ODF3h ODECH ODECH 00F6h ODF6h ODECH ODECH 00F8h ODF8h ODECH ODECH 00F8h ODECH ODECH ODECH 00F9h ODECH ODECH ODECH 00F9h ODECH ODECH ODECH 00F0h DURO ODXX0000b DURO 00F0h DURO ODXX0000b DURO 00F0h DURO ODXX0000b DURO 00F0h DURO ODXX0000b DURO 00F0h DURO ODXX0000b	00E6h	T or to trog.com	. •	70
00E9h 00E8h 00EBh 00ECh 00ECh 00EDh 00EEh 00EFh 00Fh 00Fh 00Fh 00Fh 00Fh 0			PD3	
00EAh Port P4 Direction Register PD4 00h 00EBh 00ECh 00EDh 00EDh <td>00E8h</td> <td>Port P4 Register</td> <td>P4</td> <td>XXh</td>	00E8h	Port P4 Register	P4	XXh
00EBh 00ECh 00EDh 00EFh 00EFh 00Fh 00Fh 00Fh 00Fh 00Fh 00F1h 00Fh 00F3h 00Fh 00F4h 00Fh 00Fh Pull-Up Control Register 0 00Fh Pull-Up Control Register 1 00Fh Port P1 Drive Capacity Control Register 00Fh Timer C Output Control Register 01B3h Flash Memory Control Register 4 01B3h Flash Memory Control Register 1 01B6h FMR1 01B7h Flash Memory Control Register 0				
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01B7h Flash Memory Control Register 0 FMR0 00000001b	01B6h	-		
0FFFFh Optional Function Select Register OFS (Note 2)	01B7h	Flash Memory Control Register 0	FMR0	00000001b
UFFFF Optional Function Select Register OFS (Note 2)				
	0FFFFh	Optional Function Select Register	OFS	(Note 2)

X: Undefined NOTES:

- The blank regions, 0100h to 01B2h and 01B8h to 02FFh are all reserved. Do not access locations in these regions.
 The OFS register cannot be changed by a program. Use a flash programmer to write to it.

5. Electrical Characteristics

Table 5.1 Absolute Maximum Ratings

Symbol	Parameter	Condition	Rated Value	Unit
Vcc	Supply voltage	Vcc = AVcc	-0.3 to 6.5	V
AVcc	Analog supply voltage	Vcc = AVcc	-0.3 to 6.5	٧
Vı	Input voltage		-0.3 to Vcc+0.3	V
Vo	Output voltage		-0.3 to Vcc+0.3	V
Pd	Power dissipation	Topr = 25°C	300	mW
Topr	Operating ambient temperature		-20 to 85 / -40 to 85 (D version)	°C
Tstg	Storage temperature		-65 to 150	°C

Table 5.2 Recommended Operating Conditions

Comple ed	Do	rameter	Conditions		Standard		Unit
Symbol	Pa	rameter	Conditions	Min.	Тур.	Max.	Unit
Vcc	Supply voltage			2.7	-	5.5	V
AVcc	Analog supply volt	tage		-	Vcc	_	V
Vss	Supply voltage	upply voltage		=	0	=	V
AVss	Analog supply volt	nalog supply voltage		-	0	-	V
VIH	Input "H" voltage	nput "H" voltage		0.8Vcc	_	Vcc	V
VIL	Input "L" voltage	nput "L" voltage		0	_	0.2Vcc	V
IOH(sum)	Peak sum output "H" current	Sum of all pins IOH (peak)		=	=	-60	mA
IOH(peak)	Peak output "H" cu	urrent	10		mA		
IOH(avg)	Average output "H	l" current		_	-	-5	mA
IOL(sum)	Peak sum output "L" currents	Sum of all pins IOL (peak)		=	=	60	mA
IOL(peak)	Peak output "L"	Except P1_0 to P1_3		_	-	10	mA
	currents	P1_0 to P1_3	Drive capacity HIGH	_	-	30	mA
			Drive capacity LOW	-	-	10	mA
IOL(avg)	Average output	Except P1_0 to P1_3		-	_	5	mA
	"L" current	P1_0 to P1_3	Drive capacity HIGH	-	_	15	mA
			Drive capacity LOW	-	-	5	mA
f(XIN)	Main clock input o	scillation frequency	3.0 V ≤ Vcc ≤ 5.5 V	0	-	20	MHz
				0	-	10	MHz

NOTES:

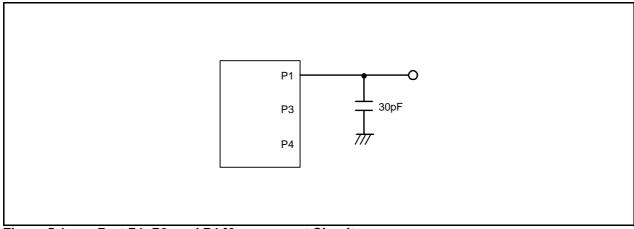
- 1. Vcc = 2.7 to 5.5 V at Topr = -20 to 85 °C / -40 to 85 °C, unless otherwise specified.
- 2. Typical values when average output current is 100 ms.

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Table 5.3 **Comparator Characteristics**

Symbol	Parameter	Conditions		Unit		
Symbol	Falametei	Conditions	Min.	±2 +2	Max.	Offic
_	Resolution		-	-	1	Bit
-	Absolute accuracy	$\phi AD = 10 \text{ MHz}^{(3)}$	-	-	±20	mV
tconv	Conversion time	φAD = 10 MHz ⁽³⁾	1	=	=	μS
Vref	Reference voltage		0	=	AVcc	V
VIA	Analog input voltage		0	=	AVcc	V
_	Comparator conversion operating clock frequency ⁽²⁾		1		10	MHz

- Vcc = 2.7 to 5.5 V at Topr = -20 to 85 °C / -40 to 85 °C, unless otherwise specified.
 If f1 exceeds 10 MHz, divided f1 and ensure the comparator conversion operating clock frequency (φAD) is 10 MHz or below.
- 3. If AVcc is less than 4.2 V, divided f1 and ensure the comparator conversion operating clock frequency (\$\phiAD\$) is f1/2 or below.



Port P1, P3, and P4 Measurement Circuit Figure 5.1

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Table 5.4 Flash Memory (Program ROM) Electrical Characteristics

Cymahal	Darameter	Conditions		Standa	ard	Lloit
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
=	Program/erase endurance ⁽²⁾	R8C/18 Group	100(3)	-	=	times
		R8C/19 Group	1,000(3)	-	-	times
-	Byte program time		ī	50	400	μS
=	Block erase time		_	0.4	9	S
td(SR-SUS)	Time delay from suspend request until suspend		=	=	97+CPU clock × 6 cycles	μS
_	Interval from erase start/restart until following suspend request		650	=	-	μS
_	Interval from program start/restart until following suspend request		0	=	-	ns
=	Time from suspend until program/erase restart		=	=	3+CPU clock × 4 cycles	μS
_	Program, erase voltage		2.7	_	5.5	V
-	Read voltage		2.7	-	5.5	V
=	Program, erase temperature		0	-	60	°C
=	Data hold time ⁽⁸⁾	Ambient temperature = 55 °C	20	-	=	year

- 1. Vcc = 2.7 to 5.5 V at Topr = 0 to 60 °C, unless otherwise specified.
- 2. Definition of programming/erasure endurance
 - The programming and erasure endurance is defined on a per-block basis.
 - If the programming and erasure endurance is n (n = 100 or 10,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one. However, the same address must not be programmed more than once per erase operation (overwriting prohibited).
- 3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).
- 4. If emergency processing is required, a suspend request can be generated independent of this characteristic. In that case the normal time delay to Suspend can be applied to the request. However, we recommend that a suspend request with an interval of less than 650 μs is only used once because, if the suspend state continues, erasure cannot operate and the incidence of erasure error rises.
- 5. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. In addition, averaging the number of erase operations between block A and block B can further reduce the effective number of rewrites. It is also advisable to retain data on the erase count of each block and limit the number of erase operations to a certain number.
- 6. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
- 7. Customers desiring programming/erasure failure rate information should contact their Renesas technical support representative.
- 8. The data hold time includes time that the power supply is off or the clock is not supplied.

Cumbal	Doromotor	Conditions		Standa	ard	Unit
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uniii
=	Program/erase endurance ⁽²⁾		10,000(3)	-	-	times
=	Byte program time (Program/erase endurance ≤ 1,000 times)		_	50	400	μS
_	Byte program time (Program/erase endurance > 1,000 times)		_	65	_	μS
=	Block erase time (Program/erase endurance ≤ 1,000 times)		=	0.2	9	S
=	Block erase time (Program/erase endurance > 1,000 times)		=	0.3	_	S
td(SR-SUS)	Time delay from suspend request until suspend		_	=	97+CPU clock × 6 cycles	μS
_	Interval from erase start/restart until following suspend request		650	_	_	μS
_	Interval from program start/restart until following suspend request		0	_	_	ns
=	Time from suspend until program/erase restart		_	=	3+CPU clock × 4 cycles	μS
_	Program, erase voltage		2.7	_	5.5	V
=	Read voltage		2.7	-	5.5	V
=	Program, erase temperature		-20 ⁽⁸⁾	=	85	°C
_	Data hold time ⁽⁹⁾	Ambient temperature = 55 °C	20	-	_	year

Table 5.5 Flash Memory (Data flash Block A, Block B) Electrical Characteristics

- 1. Vcc = 2.7 to 5.5 V at $T_{opr} = -20$ to 85 °C / -40 to 85 °C, unless otherwise specified.
- 2. Definition of programming/erasure endurance
 - The programming and erasure endurance is defined on a per-block basis.
 - If the programming and erasure endurance is n (n = 100 or 10,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one. However, the same address must not be programmed more than once per erase operation (overwriting prohibited).
- 3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).
- 4. If emergency processing is required, a suspend request can be generated independent of this characteristic. In that case the normal time delay to suspend can be applied to the request. However, we recommend that a suspend request with an interval of less than 650 μs is only used once because, if the suspend state continues, erasure cannot operate and the incidence of erasure error rises.
- 5. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erase count of each block and limit the number of erase operations to a certain number.
- 6. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
- 7. Customers desiring programming/erasure failure rate information should contact their Renesas technical support representative.
- 8. -40 °C for D version.
- 9. The data hold time includes time that the power supply is off or the clock is not supplied.

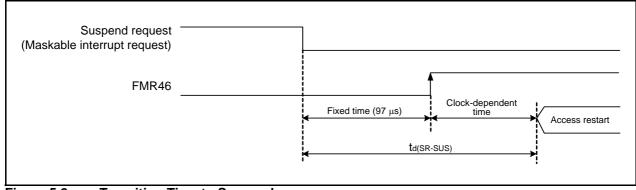


Figure 5.2 Transition Time to Suspend

Table 5.6 **Voltage Detection 1 Circuit Electrical Characteristics**

Symbol	Parameter	Condition		Unit		
Syllibol	Falanetei	Condition	Min.	Тур.	Max.	Offic
Vdet1	Voltage detection level ⁽³⁾		2.70	2.85	3.00	V
=	Voltage detection circuit self power consumption	VCA26 = 1, Vcc = 5.0 V	=	600	-	nA
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽²⁾		=	=	100	μS
Vccmin	MCU operating voltage minimum value		2.7	_	_	V

- 1. The measurement condition is Vcc = 2.7 V to 5.5 V and T_{opr} = -40°C to 85 °C.
- 2. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA26 bit in the VCA2 register to 0.
- 3. Ensure that Vdet2 > Vdet1.

Table 5.7 **Voltage Detection 2 Circuit Electrical Characteristics**

Symbol	Parameter	Condition		Unit		
Syllibol	Farameter	Condition	Min.	Тур.	Max.	Offic
Vdet2	Voltage detection level ⁽⁴⁾		3.00	3.30	3.60	V
=	Voltage monitor 2 interrupt request generation time(2)		-	40	_	μS
=	Voltage detection circuit self power consumption	VCA27 = 1, Vcc = 5.0 V	=	600	=	nA
td(E-A)	Waiting time until voltage detection circuit operation starts ⁽³⁾		-	-	100	μS

- The measurement condition is Vcc = 2.7 V to 5.5 V and Topr = -40°C to 85 °C.
 Time until the voltage monitor 2 interrupt request is generated after the voltage passes Vdet1.
- 3. Necessary time until the voltage detection circuit operates when setting to 1 again after setting the VCA27 bit in the VCA2 register to 0.
- 4. Ensure that Vdet2 > Vdet1.

Table 5.8 Reset Circuit Electrical Characteristics (When Using Voltage Monitor 1 Reset)

Symbol	Parameter	Condition	,	Standard		Unit
			Min.	Тур.	Max.	
Vpor2	Power-on reset valid voltage	-20°C ≤ Topr ≤ 85°C	-	-	Vdet1	V
tw(Vpor2-Vdet1)	Supply voltage rising time when power-on reset is deasserted ⁽¹⁾	$\label{eq:continuous} \begin{array}{l} -20^{\circ}C \leq Topr \leq 85^{\circ}C, \\ t_{w(por2)} \geq 0s^{(3)} \end{array}$	I	I	100	ms

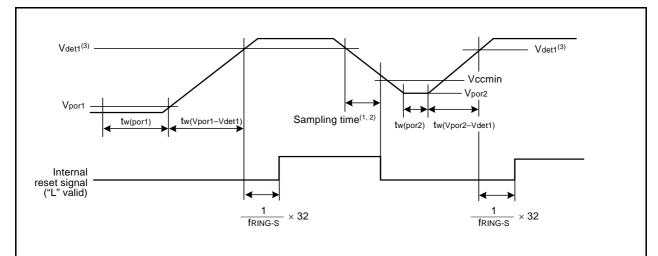
- 1. This condition is not applicable when using with $Vcc \ge 1.0 \text{ V}$.
- 2. When turning power on after the time to hold the external power below effective voltage (Vpor1) exceeds10 s, refer to Table 5.9 Reset Circuit Electrical Characteristics (When Not Using Voltage Monitor 1 Reset).
- 3. tw(por2) is the time to hold the external power below effective voltage (Vpor2).

Reset Circuit Electrical Characteristics (When Not Using Voltage Monitor 1 Reset) Table 5.9

Symbol	Parameter	Condition		Standar	d	Unit
			Min.	Тур.	Max.	
Vpor1	Power-on reset valid voltage	-20°C ≤ Topr ≤ 85°C	_	=	0.1	V
tw(Vpor1-Vdet1)	Supply voltage rising time when power-on reset is deasserted	$0^{\circ}C \leq Topr \leq 85^{\circ}C,$ $tw(por1) \geq 10 s^{(2)}$	-	-	100	ms
tw(Vpor1-Vdet1)	Supply voltage rising time when power-on reset is deasserted	$ -20^{\circ}C \leq Topr < 0^{\circ}C, \\ tw(por1) \geq 30 \ s^{(2)} $	-	=	100	ms
tw(Vpor1-Vdet1)	Supply voltage rising time when power-on reset is deasserted	$ -20^{\circ}C \leq Topr < 0^{\circ}C, $ $ tw(por1) \geq 10 \ s^{(2)} $	-	=	1	ms
tw(Vpor1-Vdet1)	Supply voltage rising time when power-on reset is deasserted	$0^{\circ}C \leq Topr \leq 85^{\circ}C,$ $tw(por1) \geq 1 s^{(2)}$	-	-	0.5	ms

NOTES:

- 1. When not using voltage monitor 1, use with $Vcc \ge 2.7 \text{ V}$.
- 2. tw(por1) is the time to hold the external power below effective voltage (Vpor1).



- 1. Hold the voltage inside the MCU operation voltage range (Vccmin or above) within the sampling time.
- The sampling clock can be selected. Refer to 7. Voltage Detection Circuit for details.
 Vdet1 indicates the voltage detection level of the voltage detection 1 circuit. Refer to 7. Voltage Detection Circuit for details.

Figure 5.3 **Reset Circuit Electrical Characteristics**

Table 5.10 High-speed On-Chip Oscillator Circuit Electrical Characteristics

Symbol	Parameter	Condition	,	Unit		
Symbol	Farameter	Condition	Min.	Тур.	Max.	Offic
_	High-speed on-chip oscillator frequency when the reset is deasserted	Vcc = 5.0 V, Topr = 25 °C	I	8	I	MHz
-	High-speed on-chip oscillator frequency temperature	0 to +60 °C/5 V ± 5 % ⁽³⁾	7.76		8.24	MHz
	supply voltage dependence ⁽²⁾	-20 to +85 °C/2.7 to 5.5 V(3)	7.68	_	8.32	MHz
		-40 to +85 °C/2.7 to 5.5 V ⁽³⁾	7.44	=	8.32	MHz

- 1. The measurement condition is Vcc = 5.0 V and $T_{opr} = 25 \,^{\circ}\text{C}$.
- 2. Refer to 10.6.4 High-Speed On-Chip Oscillator Clock for notes on high-speed on-chip oscillator clock.
- 3. The standard value shows when the HRA1 register is assumed as the value in shipping and the HRA2 register value is set to 00h.

Table 5.11 Power Supply Circuit Timing Characteristics

Svmbol	Parameter	Condition	,	Unit		
Symbol	r alametel	Condition	Min.	Тур.	Max.	Offic
td(P-R)	Time for internal power supply stabilization during power-on ⁽²⁾		1	=	2000	μS
td(R-S)	STOP exit time ⁽³⁾		=	-	150	μS

- 1. The measurement condition is Vcc = 2.7 to 5.5 V and $T_{opr} = 25$ °C.
- 2. Waiting time until the internal power supply generation circuit stabilizes during power-on.
- 3. Time until CPU clock supply starts after the interrupt is acknowledged to exit stop mode.

Table 5.12 Electrical Characteristics (1) [Vcc = 5 V]

Symbol	Doro	meter	Cond	dition	St	andard		Unit
Symbol	Fala	meter	Conc	aition	Min.	Тур.	Max.	Offic
Vон	Output "H" voltage	Except Xout	Iон = -5 mA		Vcc - 2.0	_	Vcc	V
			IOH = -200 μA		Vcc - 0.3	-	Vcc	V
		Хоит	Drive capacity HIGH	Iон = -1 mA	Vcc - 2.0	=	Vcc	V
			Drive capacity LOW	ΙΟΗ = -500 μΑ	Vcc - 2.0	-	Vcc	V
Vol	Output "L" voltage	Except P1_0 to	IoL = 5 mA	-	_	1	2.0	V
		Р1_3, Хоит	IoL = 200 μA		_	1	0.45	V
		P1_0 to P1_3	Drive capacity HIGH	IOL = 15 mA	=	=	2.0	V
			Drive capacity LOW	IOL = 5 mA	=	-	2.0	V
			Drive capacity LOW	IOL = 200 μA	=	=	0.45	V
		Хоит	Drive capacity HIGH	IOL = 1 mA	=	=	2.0	V
			Drive capacity LOW	IOL = 500 μA	=	=	2.0	V
VT+-VT-	Hysteresis	INTO, INT1, INT2, INT3, KIO, KI1, KI2, KI3, CNTRO, CNTR1, TCIN, RXD0			0.2	=	1.0	V
		RESET			0.2	_	2.2	V
lін	Input "H" current	1	VI = 5 V		_	-	5.0	μА
lı∟	Input "L" current		VI = 0 V		-	_	-5.0	μА
RPULLUP	Pull-up resistance		VI = 0 V		30	50	167	kΩ
RfXIN	Feedback resistance	XIN			-	1.0	-	ΜΩ
fring-s	Low-speed on-chip o	scillator frequency			40	125	250	kHz
VRAM	RAM hold voltage		During stop mode		2.0	-	-	V

^{1.} VCC = 4.2 to 5.5 V at Topr = -20 to 85 °C / -40 to 85 °C, f(XIN) = 20 MHz, unless otherwise specified.

Table 5.13 Electrical Characteristics (2) [Vcc = 5 V] (Topr = -40 to 85 $^{\circ}$ C, unless otherwise specified.)

Symbol	Parameter		Condition		Standard		Unit
Cymbol	1 didiliotoi			Min.	Тур.	Max.	01110
Icc	Power supply current (Vcc = 3.3 to 5.5 V) Single-chip mode, output pins are open,	High-speed mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	I	9	15	mA
	other pins are Vss, comparator is stopped		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	8	14	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	-	5	ı	mA
		Medium- speed mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	I	4	ı	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	3	_	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	2	-	mA
		High-speed on-chip oscillator mode	Main clock off High-speed on-chip oscillator on = 8 MHz Low-speed on-chip oscillator on = 125 kHz No division	-	4	8	mA
			Main clock off High-speed on-chip oscillator on = 8 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	ı	1.5	ı	mA
		Low-speed on-chip oscillator mode	Main clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 FMR47 = 1	1	110	300	μΑ
		Wait mode	Main clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = 0	-	40	80	μА
		Wait mode	Main clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = 0	_	38	76	μА
		Stop mode	Main clock off, Topr = 25 °C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = 0	_	0.8	3.0	μА

Timing Requirements

(Unless Otherwise Specified: Vcc = 5 V, Vss = 0 V at Ta = 25 °C) [Vcc = 5 V]

Table 5.14 XIN Input

Symbol	Parameter	Stan	Unit	
		Min.	Max.	Offic
tc(XIN)	XIN input cycle time	50	-	ns
twh(xin)	XIN input "H" width	25	-	ns
twl(XIN)	XIN input "L" width	25	-	ns

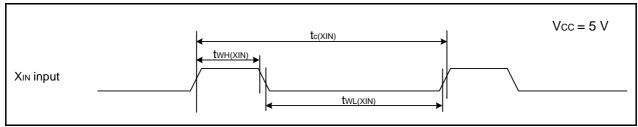


Figure 5.4 XIN Input Timing Diagram when Vcc = 5 V

Table 5.15 CNTR0 Input, CNTR1 Input, INT1 Input

Symbol	Parameter	Stan	Unit	
		Min.	Max.	Unit
tc(CNTR0)	CNTR0 input cycle time	100	=	ns
tWH(CNTR0)	CNTR0 input "H" width	40	=	ns
tWL(CNTR0)	CNTR0 input "L" width	40		ns

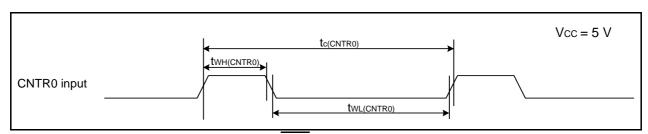


Figure 5.5 CNTR0 Input, CNTR1 Input, INT1 Input Timing Diagram when Vcc = 5 V

Table 5.16 TCIN Input, INT3 Input

Symbol	Parameter	Stan	Unit	
		Min.	Max.	Uniit
tc(TCIN)	TCIN input cycle time	400 ⁽¹⁾	-	ns
tWH(TCIN)	TCIN input "H" width	200(2)	-	ns
tWL(TCIN)	TCIN input "L" width	200(2)	I	ns

- 1. When using timer C input capture mode, adjust the cycle time to (1/timer C count source frequency x 3) or above.
- 2. When using timer C input capture mode, adjust the pulse width to (1/timer C count source frequency x 1.5) or above.

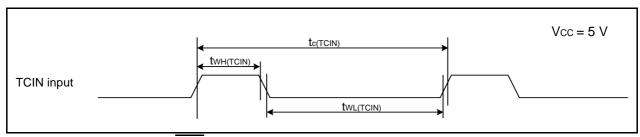


Figure 5.6 TCIN Input, INT3 Input Timing Diagram when Vcc = 5 V

Table 5.17 Senai illenace	Table	5.17	Serial	Interface
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Symbol	Parameter	Stan	Unit	
	raianielei	Min.	Max.	Offic
tc(CK)	CLKi input cycle time	200	=	ns
tW(CKH)	CLKi input "H" width	100	=	ns
tW(CKL)	CLKi input "L" width	100	=	ns
td(C-Q)	TXDi output delay time	-	50	ns
th(C-Q)	TXDi hold time	0	-	ns
tsu(D-C)	RXDi input setup time	50	=	ns
th(C-D)	RXDi input hold time	90	-	ns

i = 0 or 1

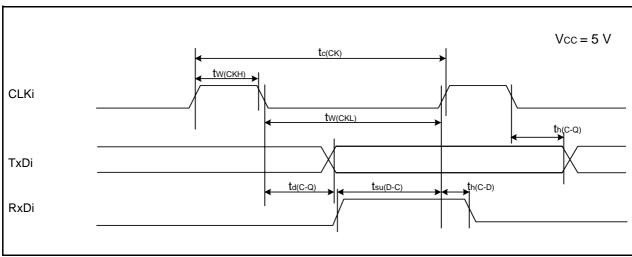


Figure 5.7 Serial Interface Timing Diagram when Vcc = 5 V

Table 5.18 External Interrupt INTO Input

Symbol	Parameter	Stan	Unit	
		Min.	Max.	Offic
tW(INH)	INTO input "H" width	250 ⁽¹⁾	-	ns
tW(INL)	INTO input "L" width	250(2)	-	ns

NOTES:

- 1. When selecting the digital filter by the INT0 input filter select bit, use an INT0 input HIGH width of either (1/digital filter clock frequency x 3) or the minimum value of standard, whichever is greater.
- 2. When selecting the digital filter by the INT0 input filter select bit, use an INT0 input LOW width of either (1/digital filter clock frequency x 3) or the minimum value of standard, whichever is greater.

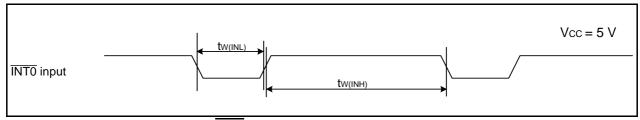


Figure 5.8 External Interrupt INTO Input Timing Diagram when Vcc = 5 V

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Electrical Characteristics (3) [Vcc = 3V] **Table 5.19**

Symbol	Paran	notor	Cond	dition	St	andard		Unit
Symbol	Parar	neter	Condition		Min. Typ		Max.	Unit
Vон	Output "H" voltage	Except Xouт	Iон = -1 mA		Vcc - 0.5	_	Vcc	V
		Хоит	Drive capacity HIGH	IOH = -0.1 mA	Vcc - 0.5	-	Vcc	V
			Drive capacity LOW	IOH = -50 μA	Vcc - 0.5	_	Vcc	V
VoL	Output "L" voltage	Except P1_0 to P1_3, Xout	IOL = 1mA		-	=	0.5	V
		P1_0 to P1_3	Drive capacity HIGH	IOL = 2 mA	-	_	0.5	V
			Drive capacity LOW	IOL = 1 mA	-	_	0.5	V
		Хоит	Drive capacity HIGH	IOL = 0.1 mA	=	-	0.5	V
			Drive capacity LOW	IOL = 50 μA	-	-	0.5	V
VT+-VT-	Hysteresis	INTO, INT1, INT2, INT3, KIO, KI1, KI2, KI3, CNTRO, CNTR1, TCIN, RXD0			0.2	-	0.8	V
		RESET			0.2	-	1.8	V
Іін	Input "H" current	•	VI = 3 V		-	-	4.0	μΑ
lıL	Input "L" current		VI = 0 V		-	-	-4.0	μΑ
RPULLUP	Pull-up resistance		VI = 0 V		66	160	500	kΩ
RfXIN	Feedback resistance	XIN			=	3.0	=	ΜΩ
fring-s	Low-speed on-chip os	cillator frequency			40	125	250	kHz
VRAM	RAM hold voltage		During stop mode		2.0	-	-	V

^{1.} Vcc = 2.7 to 3.3 V at Topr = -20 to 85 °C / -40 to 85 °C, f(XIN) = 10 MHz, unless otherwise specified.

Electrical Characteristics (4) [Vcc = 3V] (Topr = -40 to 85 °C, unless otherwise specified.) **Table 5.20**

Symbol	Parameter	Condition		Standard			Unit
Cymbol	raramotor		Condition	Min.	Тур.	Max.	
Icc	Power supply current (Vcc = 2.7 to 3.3 V) Single-chip mode, output pins are open,	High-speed mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	ı	8	13	mA
	other pins are Vss, comparator is stopped		XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	ſ	7	12	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division	_	5	ı	mA
		Medium- speed mode	XIN = 20 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	-	3	-	mA
			XIN = 16 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	I	2.5	_	mA
			XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	1.6	-	mA
		High-speed on-chip oscillator mode	Main clock off High-speed on-chip oscillator on = 8 MHz Low-speed on-chip oscillator on = 125 kHz No division	_	3.5	7.5	mA
	Low-speed on-chip oscillator mode Wait mode		Main clock off High-speed on-chip oscillator on = 8 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8	_	1.5	-	mA
		on-chip oscillator	Main clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 FMR47 = 1	-	100	280	μΑ
		Wait mode	Main clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = 0	-	37	74	μΑ
		Wait mode	Main clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = 0	=	35	70	μА
		Stop mode	Main clock off, Topr = 25 °C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = 0	-	0.7	3.0	μΑ

Timing requirements

(Unless Otherwise Specified: Vcc = 3 V, Vss = 0 V at Ta = 25 °C) [Vcc = 3 V]

Table 5.21 XIN Input

Symbol	Parameter	Stan	Unit	
		Min.	Max.	Unit
tc(XIN)	XIN input cycle time	100	=	ns
twh(xin)	XIN input "H" width	40	=	ns
tWL(XIN)	XIN input "L" width	40	=	ns

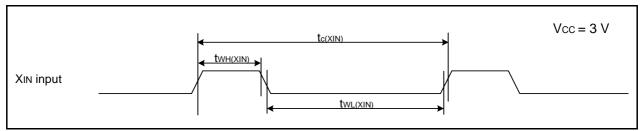


Figure 5.9 XIN Input Timing Diagram when Vcc = 3 V

Table 5.22 CNTR0 Input, CNTR1 Input, INT1 Input

Symbol	Parameter	Stan	Unit	
		Min.	Max.	Unit
tc(CNTR0)	CNTR0 input cycle time	300	-	ns
tWH(CNTR0)	CNTR0 input "H" width	120	=	ns
tWL(CNTR0)	CNTR0 input "L" width	120	-	ns

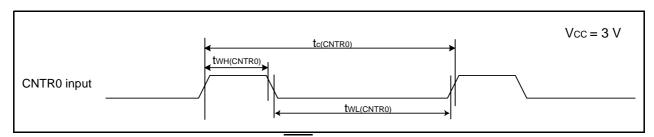


Figure 5.10 CNTR0 Input, CNTR1 Input, INT1 Input Timing Diagram when Vcc = 3 V

Table 5.23 TCIN Input, INT3 Input

Symbol	Parameter	Stan	Unit	
		Min.	Max.	Unit
tc(TCIN)	TCIN input cycle time	1,200(1)	-	ns
twh(TCIN)	TCIN input "H" width	600(2)	-	ns
twl(tcin)	TCIN input "L" width	600(2)	_	ns

- 1. When using the timer C input capture mode, adjust the cycle time to (1/timer C count source frequency × 3) or above.
- 2. When using the timer C input capture mode, adjust the width to (1/timer C count source frequency x 1.5) or above.

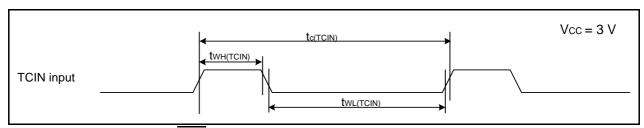


Figure 5.11 TCIN Input, INT3 Input Timing Diagram when Vcc = 3 V

Table 5.24 Serial Interface

Symbol	Parameter	Stan	Unit	
	Faidilletei	Min.	Max.	Offic
tc(CK)	CLKi input cycle time	300	=	ns
tW(CKH)	CLKi input "H" width	150	=	ns
tW(CKL)	CLKi input "L" width	150	-	ns
td(C-Q)	TXDi output delay time	=	80	ns
th(C-Q)	TXDi hold time	0	-	ns
tsu(D-C)	RXDi input setup time	70	=	ns
th(C-D)	RXDi input hold time	90	-	ns

i = 0 or 1

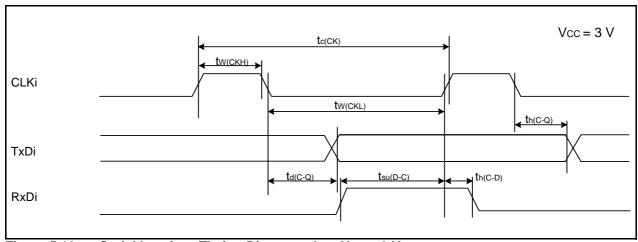


Figure 5.12 Serial Interface Timing Diagram when Vcc = 3 V

Table 5.25 External Interrupt INTO Input

Symbol	Parameter		Standard	
			Max.	Unit
tW(INH)	INTO input "H" width	380 ⁽¹⁾	-	ns
tW(INL)	INTO input "L" width	380(2)	-	ns

- 1. When selecting the digital filter by the INT0 input filter select bit, use an INT0 input HIGH width of either (1/digital filter clock frequency x 3) or the minimum value of standard, whichever is greater.
- 2. When selecting the digital filter by the INT0 input filter select bit, use an INT0 input LOW width of either (1/digital filter clock frequency x 3) or the minimum value of standard, whichever is greater.

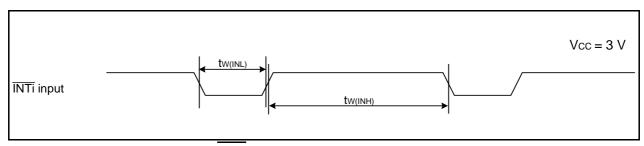
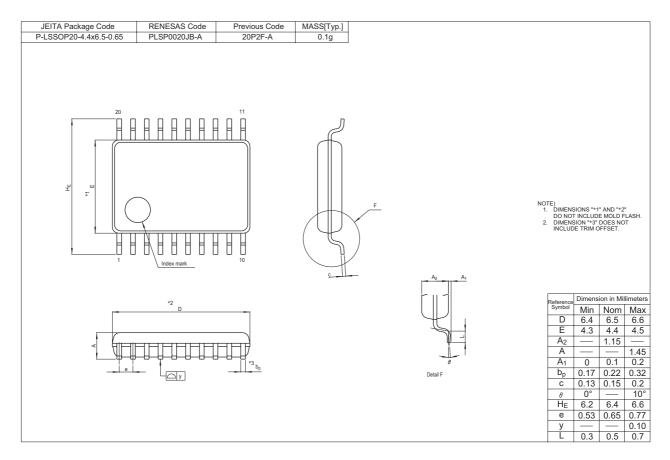
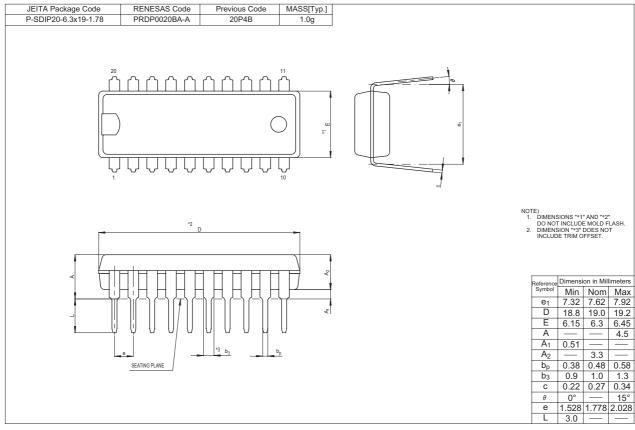
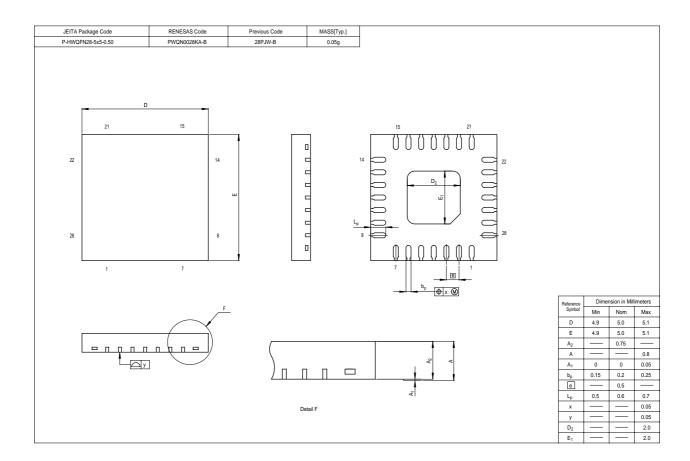


Figure 5.13 External Interrupt INTO Input Timing Diagram when Vcc = 3 V

Package Dimensions







REVISION HISTORY

R8C/18 Group, R8C/19 Group Datasheet

Boy	Doto	Description				
Rev.	Date	Page	Summary			
0.10	Nov 15, 2004	_	First Edition issued			
0.20	Jan 11, 2005	5, 6	Tables 1.3 and 1.4: The date updated			
0.21	Apr 04, 2005	2, 3	Tables 1.1 and 1.2: Partly revised			
		4	Figure 1.1: Partly revised			
		5, 6	Tables 1.3 and 1.4: Partly revised			
		5, 6	Figure 1.2 and 1.3: Partly revised			
		7, 8	Figure 1.4 and 1.5: Partly revised			
		10	Table 1.6: Partly revised			
		16	Table 4.1: Partly revised			
		17	Table 4.2: Partly revised			
		18	Table 4.3: Partly revised			
		20	Package Dimensions are revised			
1.00	May 27, 2005	5, 6	Tables 1.3 and 1.4: Partly revised			
		9	Table 1.5: Partly revised			
		25	Table 5.9: Revised			
		26	Table 5.10: Partly revised			
		28	able 5.13: Partly revised			
		32	Table 5.20: Partly revised			
1.10	Jun 09, 2005	26	Table 5.10: Partly revised			
1.20	Nov 01, 2005	3	Table 1.2 Performance Outline of the R8C/19 Group; Flash Memory: (Data area) → (Data flash) (Program area) → (Program ROM) revised			
		4	Figure 1.1 Block Diagram; "Peripheral Function" added, "System Clock Generation" → "System Clock Generator" revised			
		6	Table 1.4 Product Information of R8C/19 Group; ROM capacity: "Program area" → "Program ROM", "Data area" → "Data flash" revised			
		9	Table 1.5 Pin Description; Power Supply Input: "VCC/AVCC" → "VCC", "VSS/AVSS" → "VSS" revised Analog Power Supply Input: added			
		11	Figure 2.1 CPU Register; "Reserved Area" → "Reserved Bit" revised			
		13	2.8.10 Reserved Area; "Reserved Area" → "Reserved Bit" revised			
		15	3.2 R8C/19 Group, Figure 3.2 Memory Map of R8C/19 Group; "Data area" → "Data flash", "Program area" → "Program ROM" revised			

REVISION HISTORY			₹Y	R8C/18 Group, R8C/19 Group Datasheet		
Pay Data			Description			
Rev.	Date	Page		Summary		
1.20	Nov 01, 2005	16	0009h: 000Ah:	SFR Information(1); "XXXXXX00b" → "00h" "00XXX000b" → "00h" "XXXXX000b" → "00h" revised		
		18	0085h: 0086h: 0087h: 008Ch: 008Dh:	SFR Information(3); "Prescaler Z" → "Prescaler Z Register" "Timer Z Secondary" → "Timer Z Secondary Register" "Timer Z Primary" → "Timer Z Primary Register" "Prescaler X" → "Prescaler X Register" "Timer X" → "Timer X Register" 0091h: "Timer C" → "Timer C Register" revised		
		22		Flash Memory (Program ROM) Electrical Characteristics; 3 and 5 revised, NOTE8 deleted		
		23		Flash Memory (Data flash Block A, Block B) Electrical ristics; NOTES 1 and 3 revised		
		25		Reset Circuit Electrical Characteristics (When Using Voltage Reset); NOTE 2 revised		
		26	Table 5.10 High-speed On-Chip Oscillator Circuit Electrical Characteristics; "High-Speed On-Chip Oscillator" → "High-Speed On-Chip Oscillator Frequency" revised NOTE 2, 3 added			
		28		3 Electrical Characteristics (2) [Vcc = 5V]; deleted		
		32		D Electrical Characteristics (4) [Vcc = 3V]; I deleted		
1.30	Dec 16, 2005	_	Products	of PWQN0028KA-B package included		
		5, 6	Table 1.3,	Table 1.4 revised		
		24		Flash Memory (Program ROM) Electrical Characteristics; pient temperature		
		25		Flash Memory (Data flash Block A, Block B) Electrical ristics; Ta → Ambient temperature		
		30, 34	Table 5.13	3, Table 5.20; The title revised, Condition of Stop Mode added		
		32, 36	Table 5.17	7, Table 5.24; td(C-Q) and tsu(D-C) revised		
		37, 38	Package	Dimensions revised		
1.40	Apr 14, 2006	2, 3	•	Table 1.2; : Internal 8 → 10 sources,		
		5, 6	Table 1.3,	Table 1.4; Type No. added, deleted		
		16, 17	Figure 3.1	, Figure 3.2; Part Number added, deleted		
		24, 25	Table 5.4, Conditions	Table 5.5; s: VCC = 5.0 V at Topr = 25 °C deleted		

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Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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